



Product Change Notification

Change Notification #: 114697 - 00
Change Title: Intel® GEMINAX™ L2XXS PEF66602
Chipset,
Intel® VINAX™ L2 PEF88602 V3 Line
Driver,
Intel® XWAY™ HNX106 PEF2401
Transceiver,
PCN 114697-00, Product Discontinuance,
End Of Life
Date of Publication: June 20, 2016

Key Characteristics of the Change:

Product Discontinuance

Forecasted Key Milestones:

Last Product Discontinuance Order Date:	Dec 31, 2016
Last Product Discontinuance Shipment Date:	Jun 30, 2017

Description of Change to the Customer:

Intel is announcing the discontinuance of the products listed within the affected products table within this PCN notice.

The wafer process used to produce the affected products was discontinued. The production will be stopped as soon as the last orders are processed.

Customers should place their Last Time Orders by December 31, 2016 and delivery of all orders must be taken no later than June 30, 2017.

Customer Impact of Change and Recommended Action:

Please determine your remaining demand and place your "Last Product Discontinuance Orders" in accordance with the "Key Milestones" listed above.

Please contact your local Intel Sales Office or Distributor if you require more information or need assistance in selecting a replacement product.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	S-Spec	MM#	Stepping
Intel® VINAX™ L2 PEF88602 V3 Line Driver	PEF88602VV3X	S LLBY	946374	C1
Intel® GEMINAX™ L2XXS PEF66602 Chipset	PEF66602V	S LLAP	946953	C1
Intel® VINAX™ L2 PEF88602 V3 Line Driver	PEF88602VV3X	S LLBW	946954	C1
Intel® XWAY™ HNX106 PEF2401 Transceiver	PEF2401V	S LLHK	947045	A1

PCN Revision History:

Date of Revision:
June 20, 2016

Revision Number:
00

Reason:
Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

Americas Contact: asmo.pcn@intel.com

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